



A Product Line of Diodes Incorporated

DMN2300UFB

Product Summary

| V _{(BR)DSS} | R _{DS(on)} | I _D max T _A = +25°C | |
|----------------------|--------------------------------|--|--|
| | 175mΩ @ V _{GS} = 4.5V | 1.30A | |
| 20V | 240mΩ @ V _{GS} = 2.5V | 1.11A | |
| | 360mΩ @ V _{GS} = 1.8V | 0.91A | |

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Load Switch

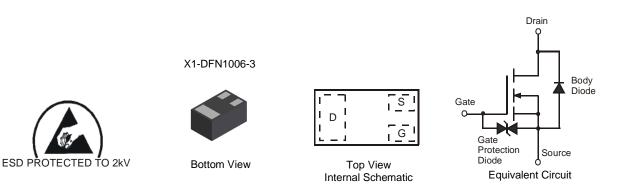
20V N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Footprint of just 0.6mm² thirteen times smaller than SOT23
- 0.5mm profile ideal for low profile applications
- On resistance <200m Ω @ V_{GS} = 4.5V
- Low Gate Threshold Voltage
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- ESD Protected Gate 2KV
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: X1-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.001 grams (Approximate)



Ordering Information (Note 4)

| Part Number | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|---------------|---------|--------------------|-----------------|-------------------|
| DMN2300UFB-7 | NI | 7 | 8 | 3,000 |
| DMN2300UFB-7B | NI | 7 | 8 | 10,000 |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

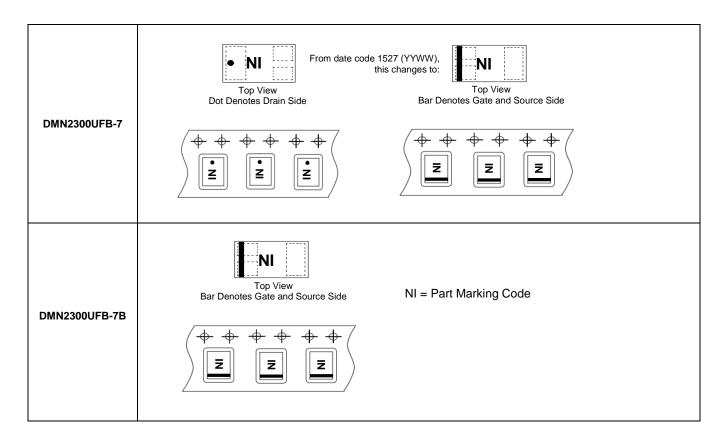
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information





DMN2300UFB

Maximum Ratings (@T_A = +25°C unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit | |
|-------------------------------|-----------------|---|-------|----------------------|---|
| Drain-Source Voltage | | V _{DSS} | 20 | V | |
| Gate-Source Voltage | | V _{GSS} | ±8 | V | |
| Continuous Drain Current | Steady State | $T_A = +25^{\circ}C$ (Note 5) $T_A = +85^{\circ}C$ (Note 5) $T_A = +25^{\circ}C$ (Note 6) | ID | 1.32 0.94 1.78 | A |
| Pulsed Drain Current (Note 7) | | I _{DM} | 8 | А | |

Thermal Characteristics (@TA = +25°C unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 5) | PD | 0.468 | W |
| Power Dissipation (Note 6) | PD | 1.2 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{0JA} | 267 | °C/W |
| Thermal Resistance, Junction to Ambient (Note 6) | R _{0JA} | 104 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

| Characteristic | Symphol | Min | Tum | Max | Unit | Test Condition | |
|--|----------------------|------|-------|------|------|--|--|
| | Symbol | WIIN | Тур | wax | Unit | Test Condition | |
| OFF CHARACTERISTICS (Note 8) | | | 1 | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 20 | - | - | V | $V_{GS} = 0V, I_D = 10\mu A$ | |
| Zero Gate Voltage Drain Current T _J = +25°C | IDSS | - | - | 1 | μA | $V_{DS} = 20V, V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | - | - | 10 | μΑ | $V_{GS} = \pm 8V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 8) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 0.45 | - | 0.95 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | |
| | | - | - | 175 | | $V_{GS} = 4.5V, I_D = 300mA$ | |
| Static Drain-Source On-Resistance | R _{DS} (ON) | - | - | 240 | mΩ | $V_{GS} = 2.5V, I_D = 250mA$ | |
| | - (- / | - | - | 360 | | $V_{GS} = 1.8V, I_D = 100mA$ | |
| Forward Transfer Admittance | Y _{fs} | 40 | - | - | mS | $V_{DS} = 3V, I_D = 30mA$ | |
| Diode Forward Voltage | V _{SD} | - | 0.7 | 1.2 | V | $V_{GS} = 0V, I_{S} = 300mA$ | |
| DYNAMIC CHARACTERISTICS | | | | | | * | |
| Input Capacitance | Ciss | - | 67.62 | - | pF | $V_{DS} = 20V, V_{GS} = 0V,$ f = 1.0MHz | |
| Output Capacitance | C _{oss} | - | 9.74 | - | pF | | |
| Reverse Transfer Capacitance | Crss | - | 7.58 | - | pF | 1 = 1.000112 | |
| Gate Resistance | Rg | - | 68.51 | - | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$ | |
| Total Gate Charge | Qg | - | 0.89 | - | nC | | |
| Gate-Source Charge | Q _{gs} | - | 0.14 | - | nC | $V_{GS} = 4.5V, V_{DS} = 10V,$ | |
| Gate-Drain Charge | Q _{gd} | - | 0.16 | - | nC | $I_D = 1A$ | |
| Turn-On Delay Time | t _{D(on)} | - | 4.92 | - | ns | | |
| Turn-On Rise Time | tr | - | 6.93 | - | ns | $V_{DS} = 10V, I_{D} = 1A$ | |
| Turn-Off Delay Time | t _{D(off)} | - | 21.71 | - | ns | $V_{GS} = 4.5V, R_G = 6\Omega$ | |
| Turn-Off Fall Time | t _f | - | 10.62 | - | ns | | |

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 25mm X 25mm square copper plate.

7. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

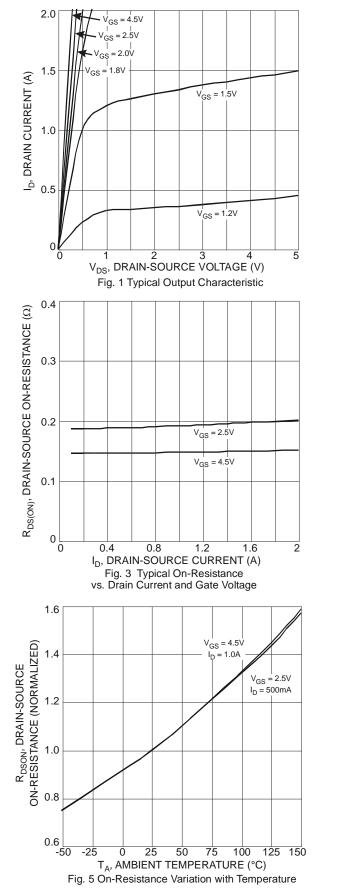
8. Short duration pulse test used to minimize self-heating effect.

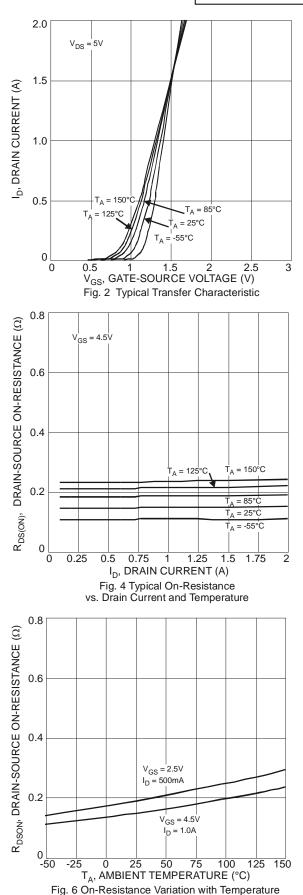


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ZETEX



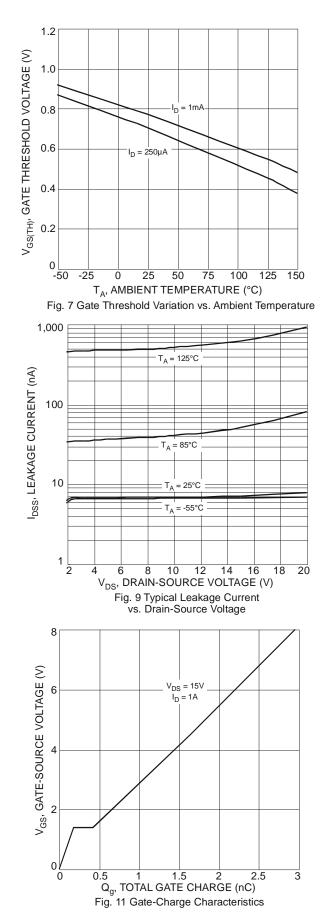


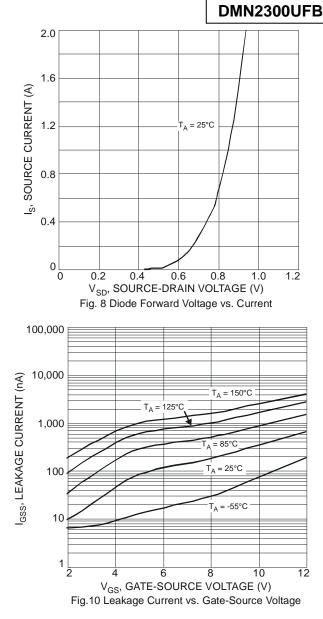
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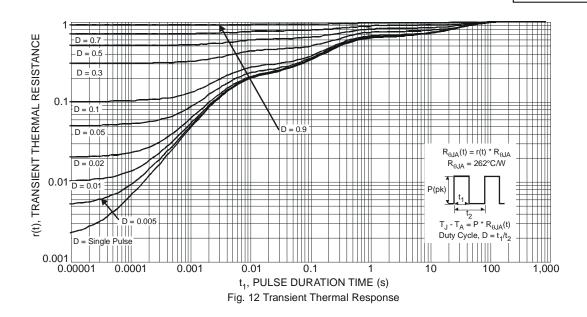
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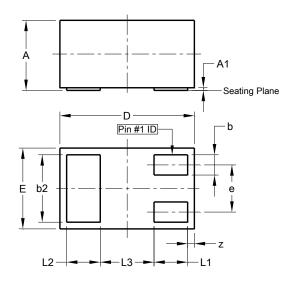




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Package Outline Dimensions

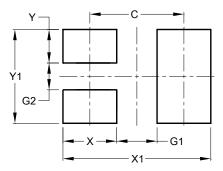
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| Х | X1-DFN1006-3 | | | | | |
|-------|----------------------|-------|------|--|--|--|
| Dim | Min | Max | Тур | | | |
| Α | 0.47 | 0.53 | 0.50 | | | |
| A1 | 0.00 | 0.05 | 0.03 | | | |
| b | 0.10 | 0.20 | 0.15 | | | |
| b2 | 0.45 | 0.55 | 0.50 | | | |
| D | 0.95 | 1.075 | 1.00 | | | |
| Е | 0.55 | 0.675 | 0.60 | | | |
| е | - | - | 0.35 | | | |
| L1 | 0.20 | 0.30 | 0.25 | | | |
| L2 | 0.20 | 0.30 | 0.25 | | | |
| L3 | - | - | 0.40 | | | |
| z | 0.02 | 0.08 | 0.05 | | | |
| All D | All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 0.70 |
| G1 | 0.30 |
| G2 | 0.20 |
| Х | 0.40 |
| X1 | 1.10 |
| Y | 0.25 |
| Y1 | 0.70 |



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